

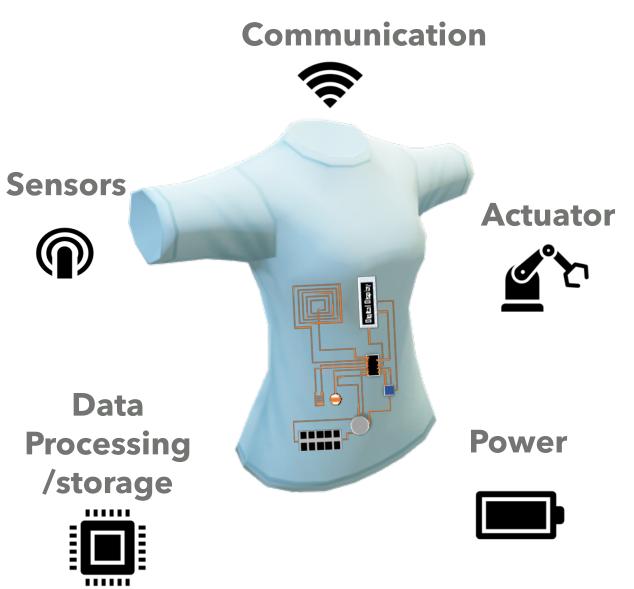
## **On-Demand Digital Fabrication and Computational Design Method for E-Textile**

**Prime contractor:** Palo Alto Research Center, Inc. (PARC);

Technical POC: Qian Ye, Giovanna Bucci, Anurag Bhattacharyya, Morad Behandish

© 2022 PARC All Rights Reserved, please limit distribution to IARPA SMART ePANTS related purposes

#### Introduction & Motivation



# Integration ?

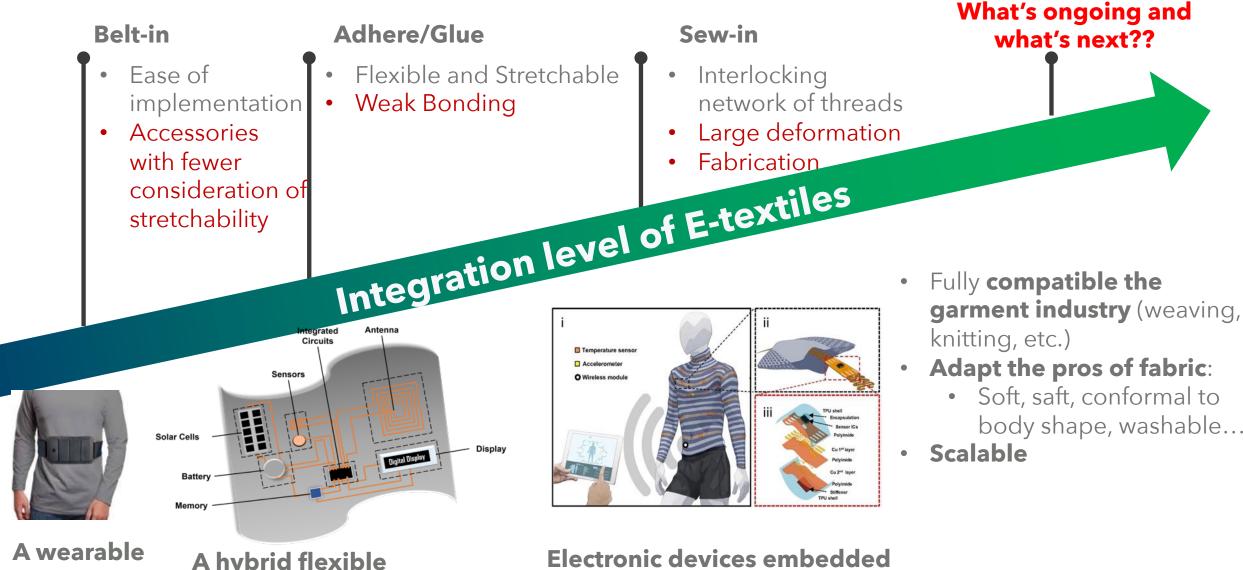
- 1. Fabrication: Textiles and electronic components
- 2. Design (an automated design approach):
  - Energy level
    - Self-powered e-textile
  - Multi-scale and multi-material

Fabrication and Design are **interdependent**:

Fabrication constraints the design

Design enables fabrication

#### 1. Fabrication: Development of Fabrication Technologies for E-textiles



Electronic heating device

#### A hybrid flexible electronics Reserved, please limit distribution to

; Reserved, please limit distribution to IARPA | purposes **Electronic devices embedded into knitted fabric** (Wicaksono et al. 2020)



1. Development of Fabrication Technologies for E-textiles What's Next: Digital Fabrication Technologies e.g., conformal weaving

A method to design and weave a conformal flexible electronics on surface

Manufacturing:

- 2D-printable electronics: more reliable, efficient, and economical.
- Surface shaped directly during weaving: no stretching, bending only

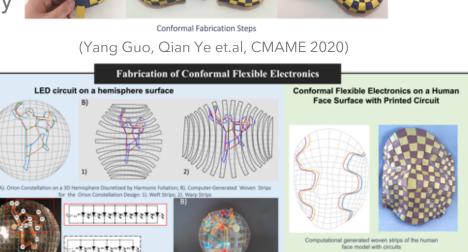
Method:

- Threads: dense without selfintersection
- Automatic pipeline suits for surfaces of various topologies

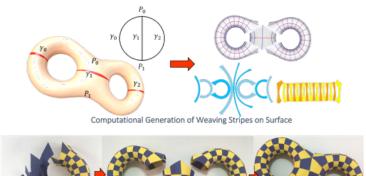
(Qian Ye et.al, IDETC 2021)

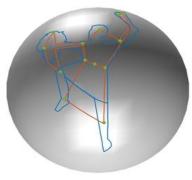






face model with circuits







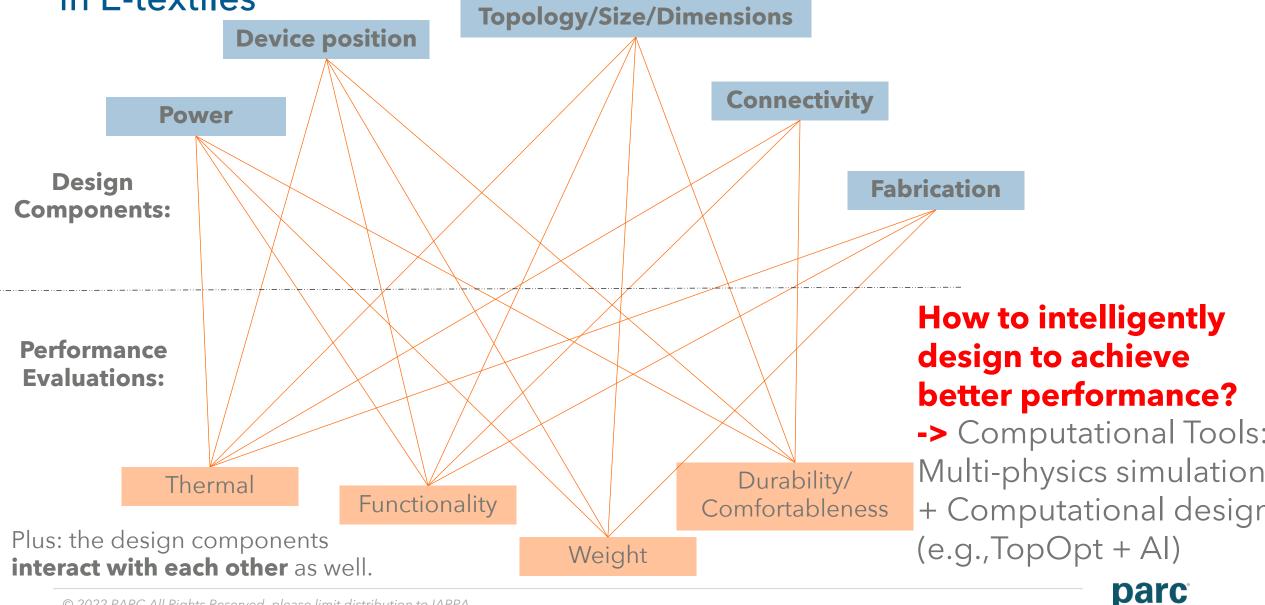
circuit

outline

stars/LED

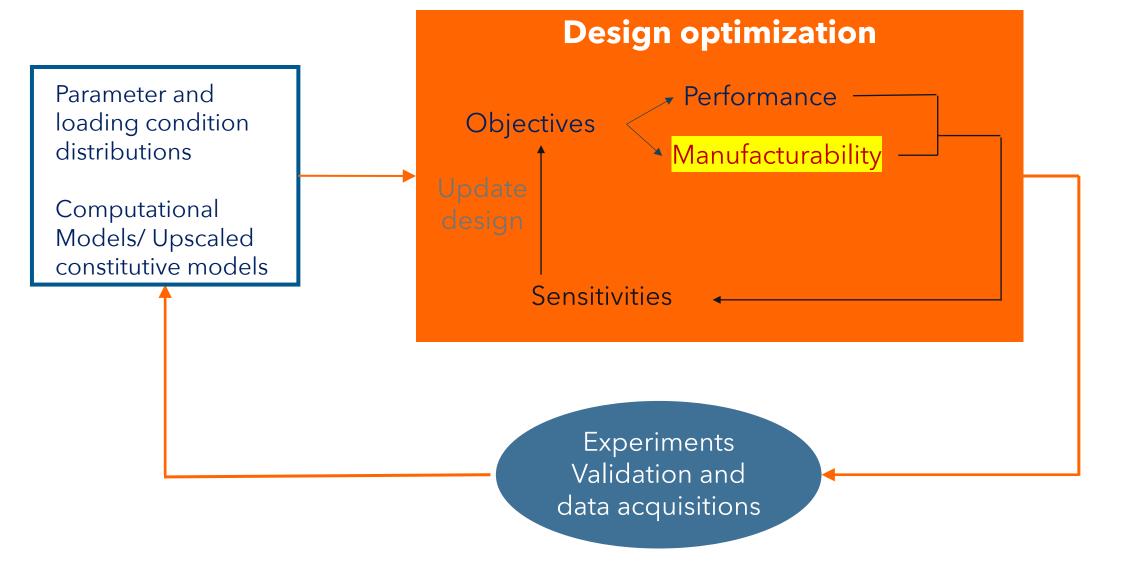
A). Circuits design: 1). Circuit on Hemisphere; 2). the Equivalent Circuits; 8). Lighting Effects

#### The interconnection between design problems and performance in E-textiles

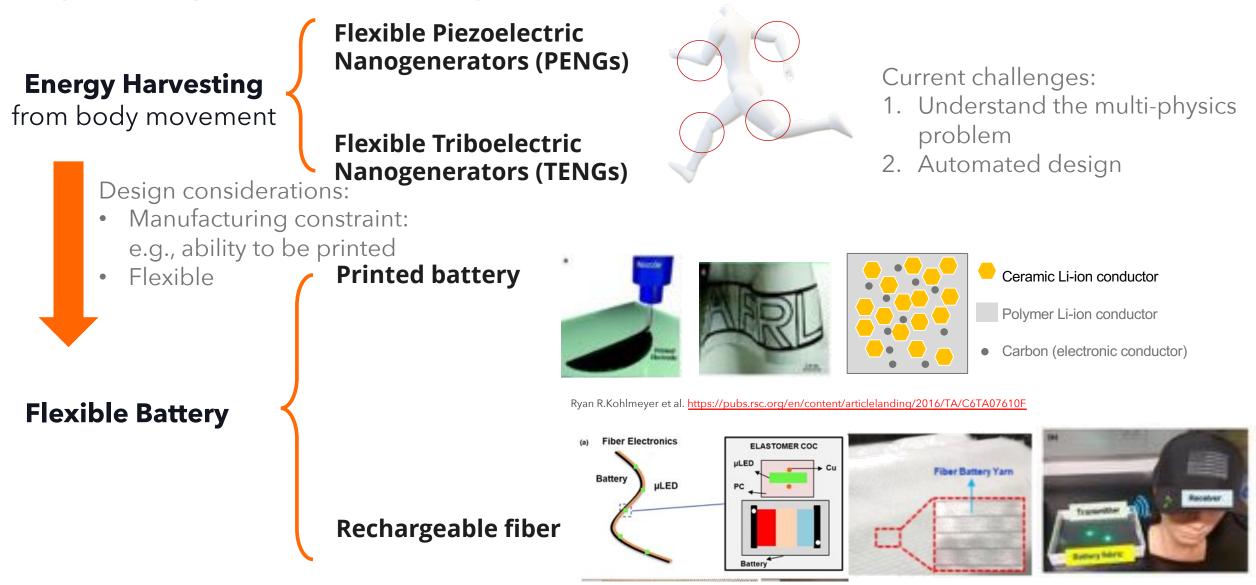


© 2022 PARC All Rights Reserved, please limit distribution to IARPA SMART ePANTS related purposes

#### Learning loop for robust-automated design



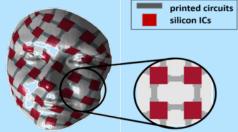
2. Design Problem 1: Improve the Integration Level of Energy Consumption Design a Self-powered E-textile system



bard

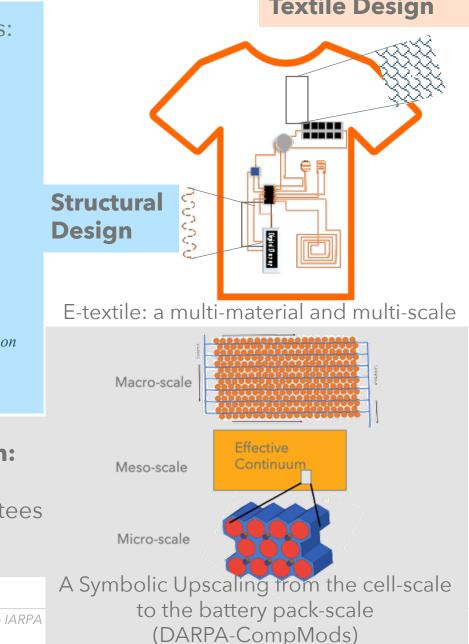
#### 3. Design Problem 2: Improve the Integration Level of Multi-material and Multi-scale

- Challenges and limitations: reliability under large deformation, fabrication cost
- Opportunity: e.g., **Topology Optimization**



Schematic of optimized flexible electronics design on a human face surface

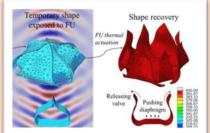
- **Rigorous homogenization:** 
  - upscale nonlinear equations with guarantees



© 2022 PARC All Rights Reserved, please limit distribution to IARPA SMART ePANTS related purposes

**Textile Design** 

- Challenges: cycling stability, nanocracks, wrinkling due to the Poisson effect
- **Opportunities:** 
  - Meta-material design:
  - Self sensing/active/ resilient: Active material



https://phys.org/news/2017-10-uniqueapproach-smart-drug-delivery.html

Interaction with the environment (Haptics)





"Scalable Tactile Glove" (STAG). (MIT, 2019) by Subramanian Sundaram, et al.



### THANK YOU



Qian Ye

qiaye@parc.com



PARC, a Xerox Company 3333 Coyote Hill Road Palo Alto, CA 94304



© 2022 PARC All Rights Reserved, please limit distribution to IARPA SMART ePANTS related purposes

#### Why PARC

- Open Innovation business model, a portfolio of novel technologies, and decades of experience across industries, cultures and technological disciplines.
- Our approach to scientific creativity is unique because we form a custom, multidisciplinary team for every project or partnership.
- This approach to combining expertise and capabilities has led to some of our most exciting R&D, technology and IP projects with startups, government agencies and Fortune 500 partners. We firmly believe that it's this continuous evolution that keeps us at the cutting edge of innovation, able to rapidly build and combine the right capabilities for your needs across the technology spectrum.

